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## TSM104W, TSM104WA QUAD OPERATIONAL AMPLIFIER AND PROGRAMMABLE VOLTAGE REFERENCE

SLOS478D-JULY 2005-REVISED AUGUST 2006

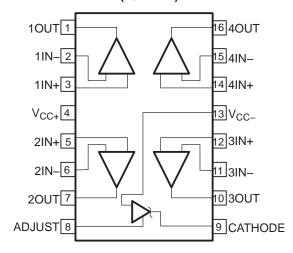
### **FEATURES**

- OPERATIONAL AMPLIFIER
  - Low Offset Voltage, Max of:
    - TSM104WA...3 mV (25°C) and 4 mV (Full Temperature)
    - TSM104W...5 mV (25°C) and 6 mV (Full Temperature)
  - Low Supply Current...375  $\mu$ A/Channel Typ at V<sub>CC</sub> = 5 V
  - Unity Gain Bandwidth...0.9 MHz Typ
  - Input Common-Mode Range Includes GND
  - Large Output-Voltage Swing...0 V to V<sub>CC</sub> - 2 V
  - Wide Supply-Voltage Range...3 V to 30 V
  - 2-kV ESD Protection (HBM)
- VOLTAGE REFERENCE
  - Adjustable Output Voltage...V<sub>REF</sub> to 36 V
  - V<sub>REF</sub> = 2.5 V With Tight Tolerance, Max of:
    - TSM104WA...0.4% (25°C) and 0.8% (Full Temperature)
    - TSM104W...1% (25°C) and 2% (Full Temperature)
  - Low Temperature Drift...7 mV Typ Over Operating Temperature Range
  - Wide Sink-Current Range...0.5 mA Typ to 100 mA
  - Output Impedance...0.2  $\Omega$  Typ

### TYPICAL APPLICATIONS

- Battery Chargers
- Switch-Mode Power Supplies
- Linear Voltage Regulation
- Data-Acquisition Systems

D (SOIC), N (PDIP), OR PW (TSSOP) PACKAGE (TOP VIEW)



### **DESCRIPTION/ORDERING INFORMATION**

The TSM104W combines the building blocks of a quad operational amplifier and an adjustable voltage reference, both of which often are used in the control circuitry of switch-mode power supplies.

For the A grade, especially tight voltage regulation can be achieved through the low offset voltage for each operational amplifier (typically 0.5 mV) and tight tolerance for the voltage reference (0.4% at 25°C and 0.8% over operating temperature range).

The TSM104W and TSM104WA are characterized for operation from -40°C to 105°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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### ORDERING INFORMATION

T <sub>A</sub>	MAX V <sub>IO</sub> AND V <sub>REF</sub> TOLERANCE (25°C)	PACE	(AGE <sup>(1)</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING
		PDIP – N	Tube of 25	TSM104WAIN	PREVIEW
		SOIC - D	Tube of 75	TSM104WAID	- TSM104WAI
	A grade 3 mV, 0.4%	30IC - D	Reel of 2500	TSM104WAIDR	13W104WAI
	0 1117, 0.170	TSSOP – PW	Tube of 75	TSM104WAIPW	- SM104AI
-40°C to 105°C		1330P – PW	Reel of 2000	TSM104WAIPWR	- SIVITU4AI
-40 C to 105 C		PDIP – N	Tube of 25	TSM104WIN	PREVIEW
		SOIC - D	Tube of 75	TSM104WID	- TSM104WI
	Standard grade 5 mV, 1%	30IC - D	Reel of 2500	TSM104WIDR	13101104001
	J 1117, 170	TSSOP – PW	Tube of 75	TSM104WIPW	- SM104I
		1330F – PW	Reel of 2000	TSM104WIPWR	31011041

<sup>(1)</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

## **Absolute Maximum Ratings**(1)

over free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
$V_{CC}$	Supply voltage			36	V
$V_{ID}$	Operational amplifier input differential voltage			36	V
VI	Operational amplifier input voltage range	-0.3	36	V	
I <sub>KA</sub>	Voltage reference cathode current		100	mA	
		D package		73	
$\theta_{JA}$	Package thermal impedance (2)(3)	N package		67	°C/W
		PW package		108	
$T_{J}$	Maximum junction temperature			150	°C
T <sub>stg</sub>	Storage temperature range		-65	150	°C

<sup>(1)</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### **Recommended Operating Conditions**

		MIN	MAX	UNIT
$V_{CC+} - V_{CC-}$	Supply voltage	3	30	V
I <sub>K</sub>	Cathode current	1	100	mA
T <sub>A</sub>	Operating free-air temperature	-40	105	°C

<sup>(2)</sup> Maximum power dissipation is a function of  $T_J(max)$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any allowable ambient temperature is  $P_D = (T_J(max) - T_A)/\theta_{JA}$ . Selecting the maximum of 150°C can affect reliability.

<sup>(3)</sup> The package thermal impedance is calculated in accordance with JESD 51-7.



# TSM104W, TSM104WA QUAD OPERATIONAL AMPLIFIER AND PROGRAMMABLE VOLTAGE REFERENCE

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### **Total Device Electrical Characteristics**

PARAMETER	TEST CONDITIONS	$T_A$	MIN	TYP	MAX	UNIT
Total supply current,	V <sub>CC+</sub> = 5 V, No load	Full range		1.4	2.4	mΛ
excluding cathode-current reference	V <sub>CC+</sub> = 30 V, No load	ruii range			4	mA

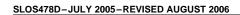
### **Operational Amplifier Electrical Characteristics**

 $V_{CC+}$  = 5 V,  $V_{CC-}$  = GND,  $V_{O}$  = 1.4 V,  $T_{A}$  = 25°C (unless otherwise noted)

	PARAMETER		TEST CONDITIONS	T <sub>A</sub>	MIN	TYP	MAX	UNIT	
		TO 110 111		25°C		1	5		
.,		TSM104W		Full range			6	.,	
$V_{IO}$	Input offset voltage	TO 140 0144		25°C		0.5	3	mv	
		TSM104WA		Full range			4	mV	
$\alpha V_{IO}$	Input offset voltage d	rift		25°C		7		μV/°C	
				25°C		2	30		
I <sub>IO</sub>	Input offset current			Full range			50	nA	
				25°C		30	150		
I <sub>IB</sub>	Input bias current			Full range			200	nA	
			$V_{CC+} = 15 \text{ V}, R_L = 2 \text{ k}\Omega,$	25°C	50	100			
$A_{VD}$	Large-signal voltage	gain	V <sub>O</sub> = 1.4 V to 11.4 V	Full range	25			V/mV	
k <sub>SVR</sub>	Supply-voltage reject	ion ratio	V <sub>CC+</sub> = 5 V to 30 V	25°C	65	100		dB	
				25°C	0		V <sub>CC+</sub> – 1.5		
$V_{ICR}$	Input common-mode	voltage range	$V_{CC+} = 30 V^{(1)}$	Full range	0		V <sub>CC+</sub> – 2	V	
	CMRR Common-mode rejection ratio			25°C	70	85			
CMRR				Full range	60			dB	
I <sub>source</sub>	Output source curren	t	V <sub>CC+</sub> = 15 V, V <sub>O</sub> = 2 V, V <sub>id</sub> = 1 V	25°C	20	40		mA	
I <sub>SC</sub>	Short circuit to GND		V <sub>CC+</sub> = 15 V	25°C		40	60	mA	
I <sub>sink</sub>	Output sink current		$V_{CC+} = 15 \text{ V}, V_O = 2 \text{ V}, V_{id} = -1 \text{ V}$	25°C	10	20		mA	
	18.1.1.1.1.1.1.1.1				27	28			
$V_{OH}$	High-level output volt	age	$V_{CC+} = 30 \text{ V}, R_L = 10 \text{ k}\Omega$	Full range	27			V	
			<b>5</b> 1010	25°C		5	20	.,	
$V_{OL}$	Low-level output volta	age	$R_L = 10 \text{ k}\Omega$	Full range			20	mv	
SR	Slew rate at unity gai	n	$V_{CC+}=15$ V, $C_L=100$ pF, $R_L=2$ k $\Omega$ , $V_I=0.5$ V to 3 V, unity gain	25°C	0.1	0.3		V/µs	
GBW	Gain bandwidth product		$V_{CC+} = 30 \text{ V}, V_I = 10 \text{ mV}, \\ C_L = 100 \text{ pF}, R_L = 2 \text{ k}\Omega, \\ f = 100 \text{ kHz}$	25°C	0.5	0.9		MHz	
THD	Total harmonic distor	tion	$V_{CC+} = 30 \text{ V}, V_O = 2 \text{ V}_{pp}, \\ C_L = 100 \text{ pF}, R_L = 2 \text{ k}\Omega, \\ f = 1 \text{ kHz}, A_V = 20 \text{ dB}$	25°C		0.01		%	
V <sub>n</sub>	Equivalent input noise	e voltage	$V_{CC}$ = 30 V, $R_S$ = 100 $\Omega$ , $f$ = 1 kHz	25°C		25		nV/√ <del>Hz</del>	
	Channel separation		1 kHz < f < 20 kHz	25°C		120		dB	

<sup>(1)</sup> The input common-mode voltage of either input should not be allowed to go below -0.3 V. The upper end of the common-mode voltage range is  $V_{CC_+} - 1.5$  V, but either input can go to  $V_{CC_+} + 0.3$  V without damage (absolute maximum ratings still must be observed).

# TSM104W, TSM104WA QUAD OPERATIONAL AMPLIFIER AND PROGRAMMABLE VOLTAGE REFERENCE





# **Voltage Reference Electrical Characteristics**

	PARAMETER		TEST CONDITIONS	T <sub>A</sub>	MIN	TYP	MAX	UNIT
		TSM104W	I <sub>K</sub> = 10 mA	25°C	2.475	2.5	2.525	
\/	Reference voltage	131/11/104	I <sub>K</sub> = 10 mA	Full range	2.45		2.55	V
$V_{REF}$	Reference voltage	TSM104WA	1 - 10 mΛ	25°C	2.49	2.5	2.51	V
		13W104WA	I <sub>K</sub> = 10 mA	Full range	2.48	.48 2.52	2.52	
$\Delta V_{REF}$	Reference input voltage de temperature range	eviation over	$V_{KA} = V_{REF}$ , $I_K = 10 \text{ mA}$	Full range		7	30	mV
$\frac{\Delta V_{REF}}{\Delta V_{KA}}$	Ratio of change in reference voltage to change in cathode voltage		$V_{KA} = 3 \text{ V to } 36 \text{ V}, I_{K} = 10 \text{ mA}$	25°C	-2	-1.1		mV/V
	Deference input ourrent		1 10 mA	25°C		1.5	2.5	^
I <sub>REF</sub>	Reference input current		I <sub>K</sub> = 10 mA	Full range	range		3	μΑ
$\Delta I_{REF}$	Reference input current de temperature range	eviation over		Full range		0.8	1.2	μΑ
I <sub>min</sub>	Minimum cathode current for regulation		$V_{KA} = V_{REF}$	25°C		0.5	1	mA
I <sub>K,OFF</sub>	Off-state cathode current			25°C		180	500	nA
z <sub>ka</sub>	Dynamic impedance <sup>(1)</sup>		$V_{KA} = V_{REF}$ , f < 1 kHz, $\Delta I_{K} = 1$ mA to 100 mA	25°C		0.2	0.5	Ω

$$\left|z_{ka}\right| \, = \frac{\Delta V_{KA}}{\Delta I_{K}} \label{eq:zka}$$
 (1) The dynamic impedance is defined as



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### **TYPICAL OPERATING CHARACTERISTICS**

 $T_{\Delta} = 25^{\circ}C$  (unless otherwise noted)

# TOTAL HARMONIC DISTORTION (THD) vs FREQUENCY

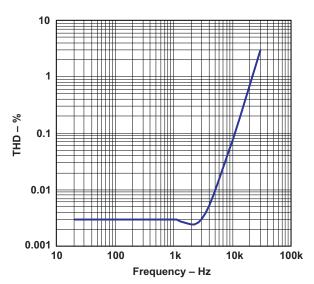


Figure 1.



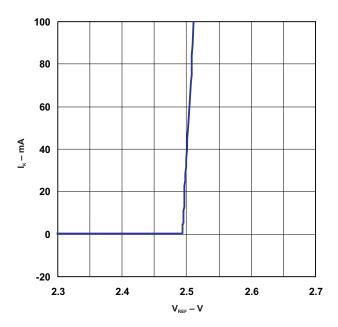


Figure 3.

# AMPLIFIER NOISE VOLTAGE VS FREQUENCY

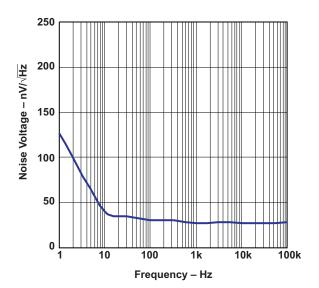


Figure 2.

V<sub>REF</sub> STABILITY VS CAPACITANCE

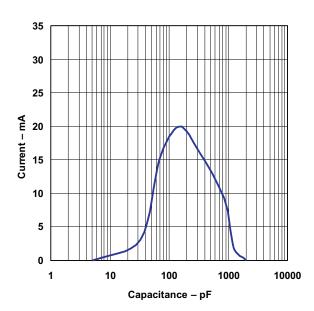
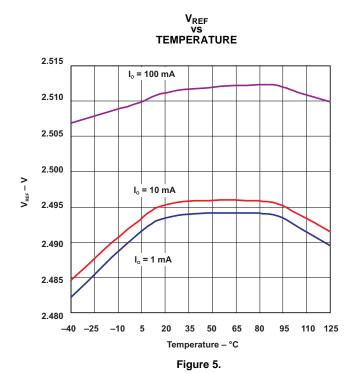


Figure 4.



### **TYPICAL OPERATING CHARACTERISTICS (continued)**

 $T_A = 25^{\circ}C$  (unless otherwise noted)







6-Feb-2020

### **PACKAGING INFORMATION**

Orderable Device	Status	Package Type	Package Drawing		Package Qty	Eco Plan	Lead/Ball Finish (6)	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
TSM104WAID	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 105	TSM104WAI	Samples
TSM104WAIDR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 105	TSM104WAI	Samples
TSM104WAIPWR	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 105	SM104AI	Samples
TSM104WIDR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 105	TSM104WI	Samples
TSM104WIPWR	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 105	SM104I	Samples

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: Til defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.



### **PACKAGE OPTION ADDENDUM**

6-Feb-2020

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# PACKAGE MATERIALS INFORMATION

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### TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

All differsions are normal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TSM104WAIDR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
TSM104WAIPWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
TSM104WIDR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
TSM104WIPWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1

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\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TSM104WAIDR	SOIC	D	16	2500	367.0	367.0	38.0
TSM104WAIPWR	TSSOP	PW	16	2000	367.0	367.0	35.0
TSM104WIDR	SOIC	D	16	2500	367.0	367.0	38.0
TSM104WIPWR	TSSOP	PW	16	2000	367.0	367.0	35.0

# D (R-PDS0-G16)

### PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.





SMALL OUTLINE PACKAGE



### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.



SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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